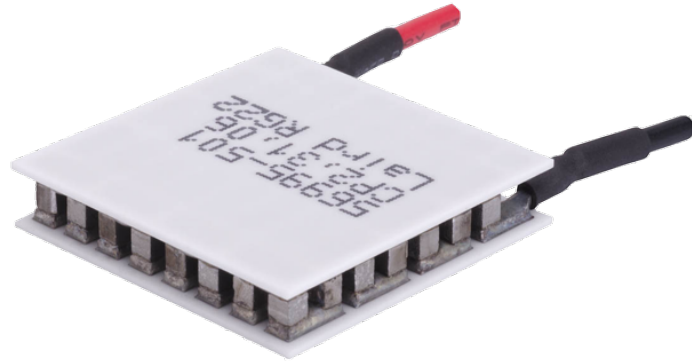


Ceramic Plate Series Thermoelectric Cooler

The CP2-31-06-L1-W4.5 is a high-performance and highly reliable standard Thermoelectric Cooler. Assembled with Bismuth Telluride semiconductor material and thermally conductive Aluminum Oxide ceramics. It has a maximum Q_c of 28.8 Watts when $\Delta T = 0$ and a maximum ΔT of 70.5 °C at $Q_c = 0$.

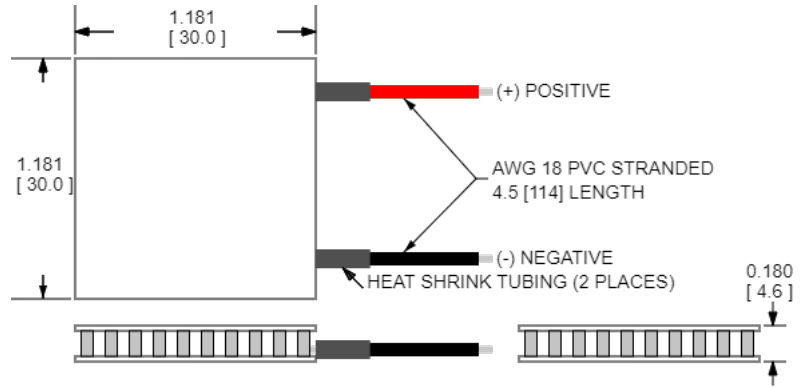


Features

- Compact geometric sizes
- DC Operation
- RoHS-compliant

Applications

- Thermoelectric Coolers for Reagent Storage
- Thermoelectric Coolers for Handheld Cosmetic Lasers
- Cooling for Centrifuges
- Heads-Up Displays, Imaging Sensors
- Peltier Cooling for Machine Vision

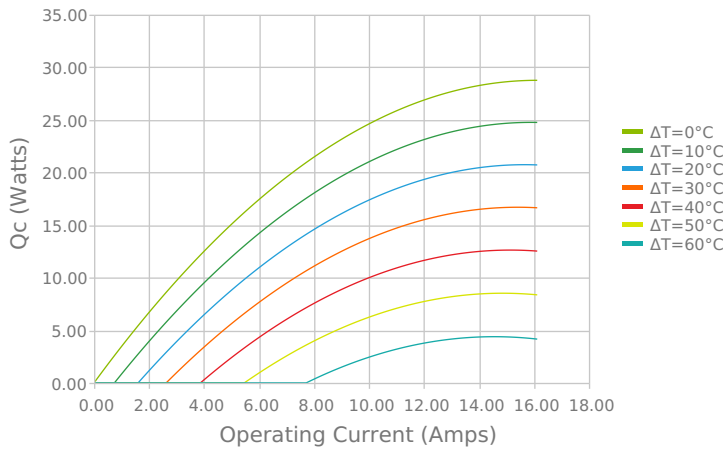


CERAMIC MATERIAL: Al_2O_3
 SOLDER CONSTRUCTION: 138°C, BiSn

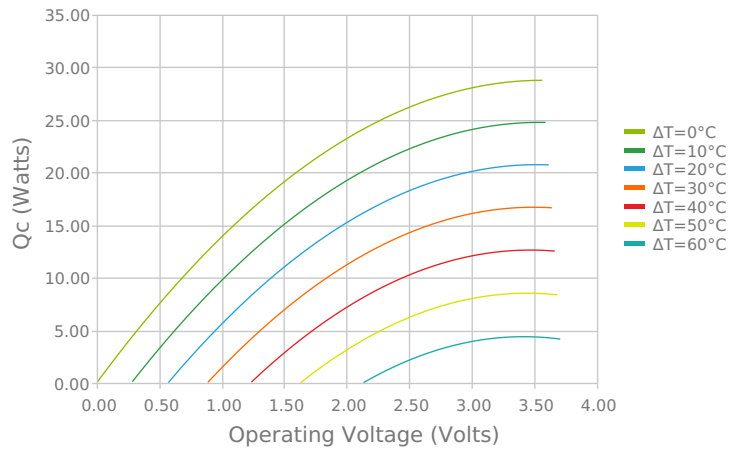
INCHES [MM]

ELECTRICAL AND THERMAL PERFORMANCE

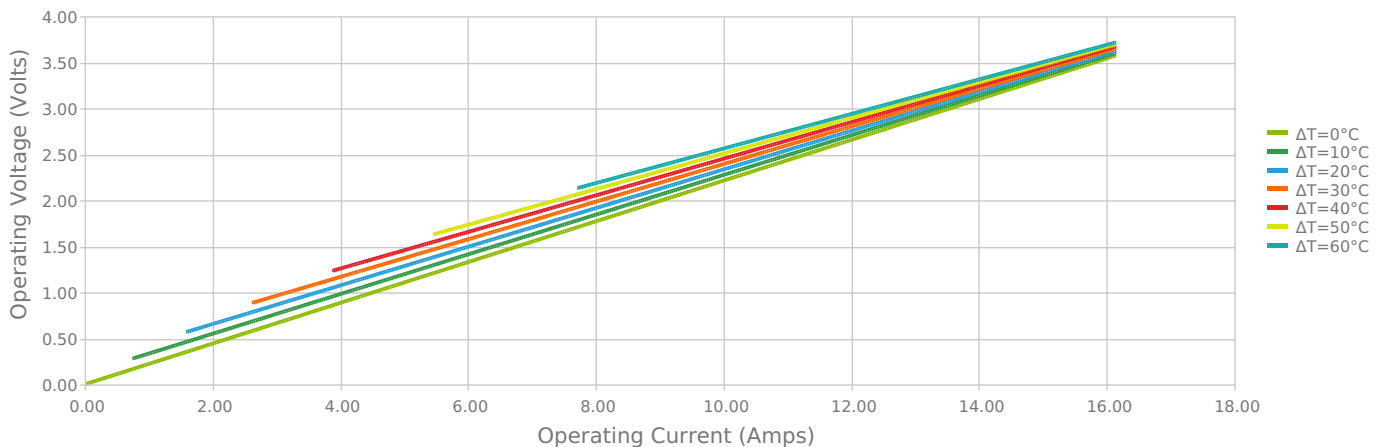
Heat Pumped at Cold Side
 $T_{hot} = 27\text{ °C}$



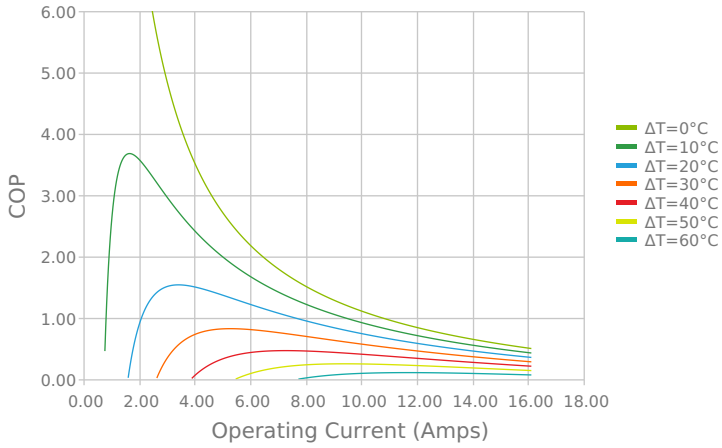
Heat Pumped at Cold Side
 $T_{hot} = 27\text{ °C}$



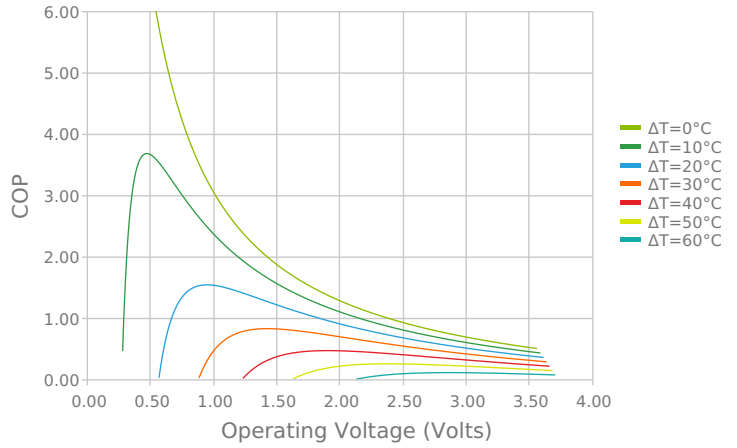
Current vs Voltage (I vs V)
 $T_{hot} = 27\text{ °C}$



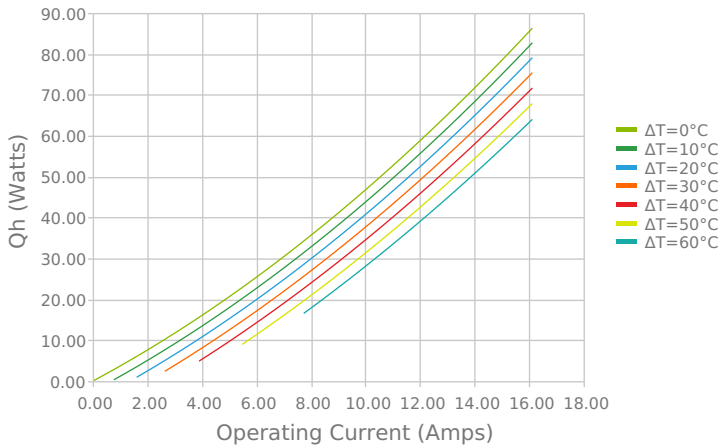
Coefficient of Performance (COP = Qc/Pin)
 Thot = 27 °C



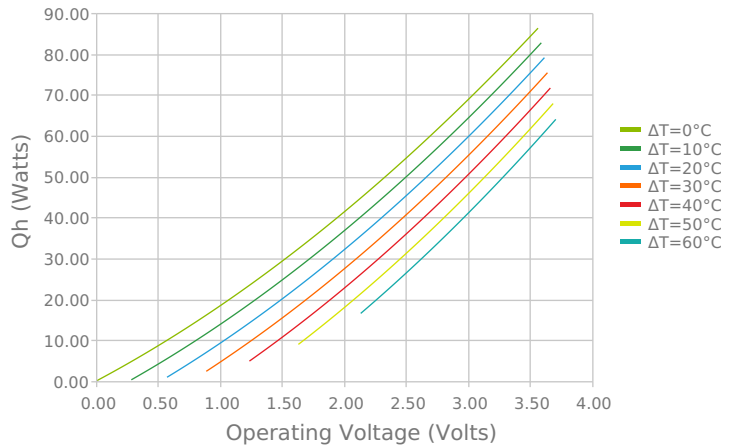
Coefficient of Performance (COP = Qc/Pin)
 Thot = 27 °C



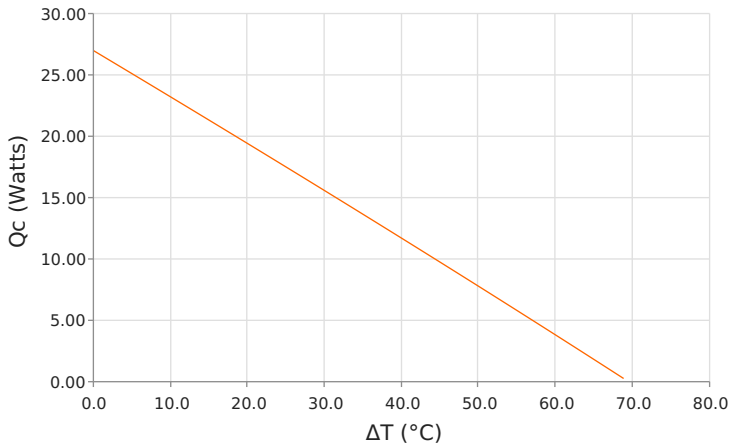
Total Heat Dissipated at Hot Side (Qh=Qc+Pin)
 Thot = 27 °C



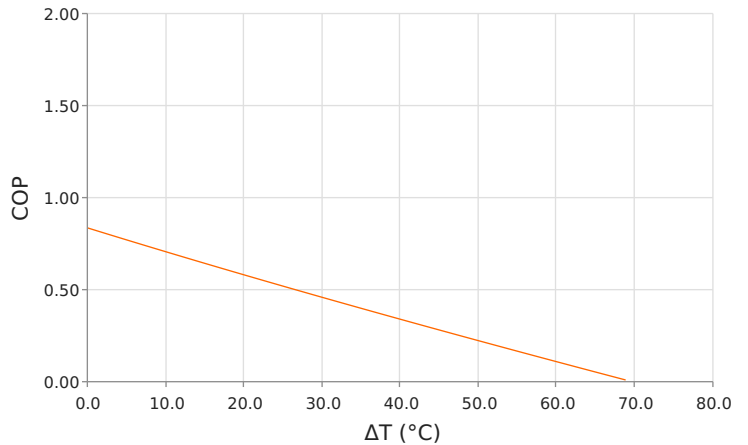
Total Heat Dissipated at Hot Side (Qh=Qc+Pin)
 Thot = 27 °C



Heat Pumped at Cold Side (Qc)
 Thot = 27 °C | Current = 12.1 Amps



Coefficient of Performance (COP = Qc/Pin)
 Thot = 27 °C | Current = 12.1 Amps



SPECIFICATIONS*

| | 27.0 °C | 35.0 °C | 50.0 °C |
|---|--------------|------------|------------|
| Hot Side Temperature | | | |
| Qcmax ($\Delta T = 0$) | 28.8 Watts | 29.6 Watts | 31.2 Watts |
| ΔT_{max} ($Q_c = 0$) | 70.5°C | 73.5°C | 78.8°C |
| I_{max} (I @ ΔT_{max}) | 14.2 Amps | 14.2 Amps | 14.0 Amps |
| V_{max} (V @ ΔT_{max}) | 3.4 Volts | 3.5 Volts | 3.8 Volts |
| Module Resistance | 0.22 Ohms | 0.23 Ohms | 0.25 Ohms |
| Max Operating Temperature | 80 °C | | |
| Weight | 18.0 gram(s) | | |

* Specifications reflect thermoelectric coefficients updated March 2020

FINISHING OPTIONS

| Suffix | Thickness | Flatness / Parallelism | Hot Face | Cold Face | Lead Length |
|--------|--------------------------------------|--|----------|-----------|---------------------|
| L1 | 4.572 ±0.025 mm 0.180 ± 0.0010 in | 0.025 mm / 0.025 mm 0.001 in / 0.001 in | Lapped | Lapped | 114.3 mm 4.50 in |

SEALING OPTIONS

| Suffix | Sealant | Color | Temp Range | Description |
|--------|---------|-------|------------|----------------------|
| | None | | | No sealing specified |

NOTES

1. Max operating temperature: 80°C
2. Do not exceed I_{max} or V_{max} when operating module
3. Reference assembly guidelines for recommended installation
4. Solder tinning also available on metallized ceramics

Any information furnished by Laird and its agents, whether in specifications, data sheets, product catalogues or otherwise, is believed to be (but is not warranted as being) accurate and reliable, is provided for information only and does not form part of any contract with Laird. All specifications are subject to change without notice. Laird assumes no responsibility and disclaims all liability for losses or damages resulting from use of or reliance on this information. All Laird products are sold subject to the Laird Terms and Conditions of sale (including Laird's limited warranty) in effect from time to time, a copy of which will be furnished upon request.

© Copyright 2019-2021 Laird Thermal Systems, Inc. All rights reserved. Laird™, the Laird Ring Logo, and Laird Thermal Systems™ are trademarks or registered trademarks of Laird Limited or its subsidiaries.

Date: 05/26/2021